

MODELING OF GRAIN BOUNDARY RESISTANCE IN A STRAIN GRADIENT CRYSTAL PLASTICITY MODEL

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Size effects are common phenomena observed in the plastic deformation of micro-specimen (see e.g. [1]). In this context, the resistance of grain boundaries against plastic flow is one important influence on the mechanical response [2].

One possibility to model such effects is the incorporation of a grain boundary yield criterion within a single-crystal strain gradient plasticity theory [3]. In addition, the gradient of an equivalent plastic strain is considered for a numerically efficient treatment of the theory. Finite Elements are used to implement the model at hand. The numerical results shown contain simulations with simplified grain aggregates under tensile loading conditions. Application of the theory to simulate the mechanical response of experimental data from the literature is presented.

Possible further refinement of the theory and application to a different load case is outlined.

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